

1035 U.S. PTO  
04/16/01

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JC996 U.S. PTO  
09/835310  
04/16/01

Box Patent Application  
Assistant Commissioner for Patents  
Washington, District of Columbia 20231

Sir:

Please file the following enclosed patent application papers:

Applicant #1, Name: KAI LU

Applicant #2, Name: \_\_\_\_\_

Title: A Packet-drop Tolerant Method for Transmitting Time-critical Data over Ethernet

☒ Specification, Claims, and Abstract: Nr. of Sheets 14

☒ Declaration: Date Signed: 2001 April 10

☒ Drawing(s): Nr. of Sheets Enc.: Formal: \_\_\_\_\_ Informal: 3

☒ Small Entity Declaration of Inventor(s) ☐ SED of Non-Inventor / Assignee / Licensee

☐ Assignment enclosed with cover sheet and recordal fee; please record and return

☒ Check for \$ 355.00 for.

☒ \$ 355.00 for filing fee (not more than three independent claims and twenty total claims are presented)

☐ \$ \_\_\_\_\_ additional if Assignment is enclosed for recordal.

☐ Disclosure Document Program reference letter.

☐ Pursuant to 35 U.S.C. §119(e)(i), applicant(s) claim priority of Provisional Patent Application Ser Nr \_\_\_\_\_  
filed \_\_\_\_\_

☒ Return Receipt Postcard Addressed to Applicant #1.

☒ **Request Under MPEP § 707.07(j):** The undersigned, a pro se applicant, respectfully requests that if the Examiner finds patentable subject matter disclosed in this application, but feels that Applicant's present claims are not entirely suitable, the Examiner draft one or more allowable claims for applicant.

Very respectfully,

Kai Lu  
Applicant #1 Signature

4320 Grove St.

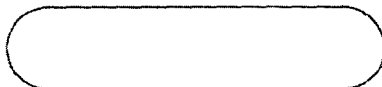
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Applicant #2 Signature

Address

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; Date of Deposit 199 \_\_\_\_\_

I hereby certify that this paper or fee is being deposited with the United States Postal Service using "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to "Box Patent Application, Assistant Commissioner for Patents, Washington, DC 20231."

Signed: \_\_\_\_\_  
Inventor